

Robot Skin Based on Touch-Area-Sensitive Tactile Element

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Abstract - In this paper, we propose a new tactile sensor skin (“Skin by Touch Area Receptor” or STAR). The skin consists of two components. One is a sensor element which detects a contact area in addition to a contact force. The element is inspired by the fact that humans can discriminate sharpness of objects sensitively on any part of their bodies in spite of their several-centimeter Two Point Discrimination Thresholds. We have developed the sensor element that has such characteristics in a very simple structure; two layers of compressible insulators (urethane foam) which are sandwiched between three pieces of stretchable conductive sheets (conductive fabric). The other component is a sensor/communication chip. The chips are arranged at the boundaries of the elements, and the chips measure the capacitances between the conductive layers and send signals through the same conductive layers. The chips enable us to connect the elements to compose a soft robot skin including no long wires.

Index Terms - Tactile sensor, Robot skin, Haptic interface, Contact area, Nonlinear elasticity.

I. INTRODUCTION

Recently, there is a growing interest in home robots that can care for the aged and young children [1]-[2] and that can be alternatives to companion animals [3]-[4]. In that situation, robots at home are required to be more cautious about surrounding environments than robots at industrial factories, because they interact with humans directly and there are

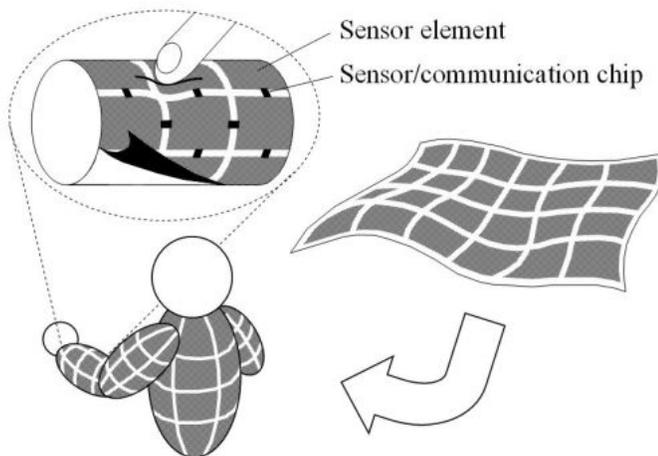


Fig. 1 Illustration of STAR (Skin by Touch Area Receptor). It is soft, stretchable, and capable of covering a large area easily.

obstacles and unpredictable events around them. To meet this requisite, robot skins which give tactile sensation to the robots are demanded in robotics [5].

The major requirements for robot skins are the following.

- They should sensitively detect rich tactile information related to such parameters as shape, pressure, friction, temperature, and so on.
- They should cover several-square-meter large areas such as whole surfaces of robots.
- They should be soft and stretchable to contact humans safely and fit robot surfaces. Softness is one of important factors to detect touch feelings, too.

In order to realize such a robot skin, various arrays of pressure-sensitive tactile sensor elements [6]-[11] have been tried. One approach to enhance the ability of the sensors for practical uses is to array the elements in high density. However, we have no practical techniques available now with which we can mount a million of tactile elements with 1 mm spacing in a stretchable sensor skin.

We propose a new tactile sensor skin (“Skin by Touch Area Receptor” or STAR) which is based on a new tactile sensing method to solve the problem that is mentioned above. In our method, a sensor element dares to have a large sensing area (several square centimeters) unlike the other elements in the literature, and it acquires not only a contact force but also a contact area [12]. Owing to the additional sensing parameter, i.e. the contact area, a robot skin which detects minute shape features of object surfaces is easily realized by arraying the elements in low density. In consequence, we can cover a whole surface of a robot with a small number of the elements (Fig. 1).

The above proposition is inspired by the characteristics of the human tactile sensation. While Two Point Discrimination Thresholds (TPDT) of humans are as large as several centimeters except on especially sensitive parts, faces and hands [13], humans can discriminate sensitively sharpness of objects even on such large TPDT parts. Although we still don't know exactly why and how the human skins perform like that, from these facts, we consider that sharpness is one of key components to produce general human tactile sensation [14], and suppose that sensitivity to sharpness is a high priority for human-like sensor skins.

Based on the proposition, we developed a new tactile sensor element [12]. The sensor element consists of two layers

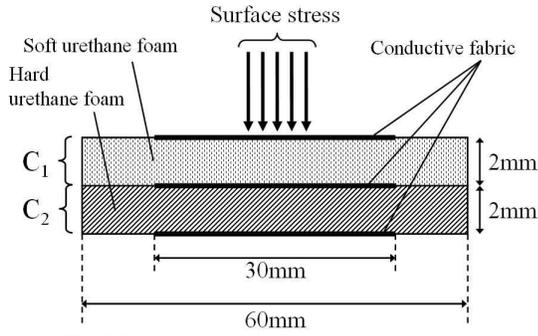


Fig. 2 Cross-section of sensor element prototype.

of compressible insulators and three pieces of stretchable conductive sheets. In order to acquire the contact force and the contact area, we make use of the nonlinear elasticity of the insulators.

In this paper, we connect the sensor elements to realize a robot skin by a new connecting method well suited to the elements. In the method, the conductive pieces work not only as sensor elements but also as communication paths when sensor/communication chips are placed at the boundaries of the conductive pieces [15]. Thus, wires to the sensor elements are no longer needed and stretchable skins can be realized.

The rest of this paper is organized as follows. Firstly, section II describes the structure and the sensing theory of the sensor element. Results of experiments examining the feasibility of the element are also showed. After that, we explain about the proposed sensor skin system in section III. Developed CMOS LSI chips for connecting the sensor elements without long wires are introduced. Finally, we conclude this paper.

II. SENSOR ELEMENT

A. Structure

The structure of our sensor element is very simple. In Fig. 2, we show schematically the cross-section of the sensor element prototype. The sensor element consists of two compressible insulator layers; the upper and lower layers are soft (15 kg/m^3) and hard (60 kg/m^3) urethane foam, respectively, and each layer is 2 mm in thickness. There are three pieces of stretchable conductive fabric on the soft layer, between the soft and hard, and under the hard. Each piece has an area of $30 \times 30 \text{ mm}^2$. The side length of the conductive fabric piece is comparable to the TPDT on human forearms. The insulator layers and the conductive pieces adhere to each other by soft double-faced tape, and two capacitors are formed in the layers. Supposing that a robot surface is hard, we attach the bottom of the sensor element prototype to an acrylic base.

B. Sensing Theory

We suppose a surface stress as illustrated in Fig. 3; a uniform surface stress distribution $\sigma(x, y)$ [Pa] is vertically loaded to the surface of the sensor element in a contact field S , that is,

$$\sigma(x, y) \equiv \begin{cases} F/S & \text{if } (x, y) \in S \\ 0 & \text{if } (x, y) \notin S \end{cases} \quad (1)$$

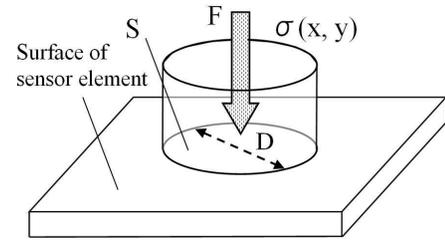


Fig. 3 Supposed surface stress distribution $\sigma(x, y)$.

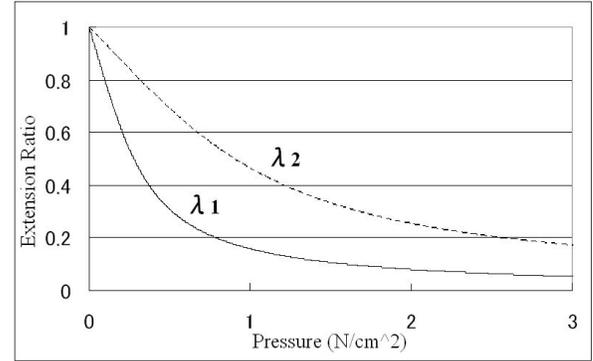


Fig. 4 Relationship between surface stress σ and extension ratio λ_n . Soft layer λ_1 is more easily compressed than hard layer λ_2 .

where F [N] is the total intensity of the contact force and S [m^2] is the area of S . Now we take note of the area of S , not the shape, so we suppose that S is circular for simplicity.

We also assume the following. First, the nonlinear elasticity of the insulator layers is the entropy elasticity [16] expressed as

$$\sigma = \frac{E_n}{3} \left(\frac{1}{\lambda_n} - \lambda_n^2 \right) \quad (n = 1, 2) \quad (2)$$

$$\lambda_n \equiv 1 - \frac{\Delta d_n}{d_n} \quad (3)$$

where n is the layer identification; $n = 1$ means the upper soft layer and 2 the lower hard layer. E_n [Pa], λ_n and d_n [m] are the Young's modulus, the extension ratio and the initial thickness of the layer n , respectively. E_1 is about 4.8 kPa and E_2 is 15 kPa. The following expression of λ_n (Fig. 4) is obtained by solving (2),

$$\lambda_n = \sqrt[3]{\frac{1}{2} + \sqrt{\frac{1}{4} + \left(\frac{\sigma}{E_n}\right)^3}} + \sqrt[3]{\frac{1}{2} - \sqrt{\frac{1}{4} + \left(\frac{\sigma}{E_n}\right)^3}} \quad (4)$$

Second, the conductive pieces have negligible tensions and the Poisson's ratios of the insulator layers are zero, which means that a displacement distribution $\Delta d_n(x, y)$ [m] is determined simply by the local value of $\sigma(x, y)$.

We measure electric capacitances C_n [F] between the conductive pieces to detect $\Delta d_n(x, y)$. Ignoring fringing fields, the capacitances are formulated as

$$C_n = \iint_{\text{Element}} \frac{\varepsilon_n}{d_n - \Delta d_n(x, y)} dx dy \quad (5)$$

where ε_n [F/m] is the dielectric constant of the layer n . If we can make the second assumption mentioned above, (C_1, C_2) is

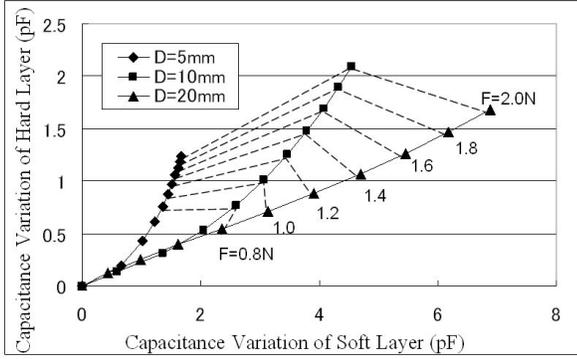


Fig. 5 Simulation result. Calculated $(\Delta C_1, \Delta C_2)$ s for various (F, S) s. D is defined as $D = 2\sqrt{S/\pi}$ to represent a diameter of S for a circular object.

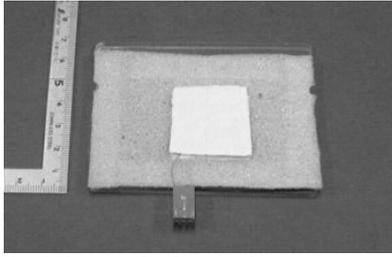


Fig. 6 Photograph of sensor element prototype.

uniquely determined by (F, S) . Then the key question is whether the inverse mapping from (C_1, C_2) to (F, S) is possible or not for the layers, 1 and 2, having different hardness.

Fig. 5 shows a numerical simulation result for the elasticity moduli $E_1 = 4.8$ kPa and $E_2 = 15$ kPa. It shows that $(\Delta C_1, \Delta C_2)$ s for various (F, S) s span a two dimensional space, where $(\Delta C_1, \Delta C_2)$ are the capacitance variations by the applied force, and D is the parameter defined as

$$D \cong 2\sqrt{S/\pi} \quad (6)$$

to represent the diameter of S for a circular object. It implies that we can determine (F, S) uniquely from $(\Delta C_1, \Delta C_2)$ when F is larger than a threshold, now around 1.0 N.

Note that the nonlinear elasticity of the insulator layers plays a key role in the sensing theory. In the case of linear elastic insulator layers, i.e. $\sigma \ll E_n$, it is impossible to estimate S from (C_1, C_2) . λ_n of the linear elastic insulator is calculated by approximating (4) as

$$\lambda_n \cong 1 - \sigma/E_n \quad (7)$$

Then (5) can be approximated as

$$C_n \cong C_{n0} + \varepsilon_n F/d_n E_n \quad (8)$$

where C_{n0} is the initial capacitance of the layer n . (8) means that neither C_1 nor C_2 contains the parameter S .

C. Experiments and Results

We conducted experiments to examine the feasibility of the proposed sensing method. We measured C_n of a sensor element prototype (Fig. 6) by a self oscillation method; we generated a RC oscillation including the sensor element as the capacitor, and counted pulses per 2 ms by a 16-bit counter. A PC imported data via a digital I/O, and achieved around 80 Hz effective sampling rate.

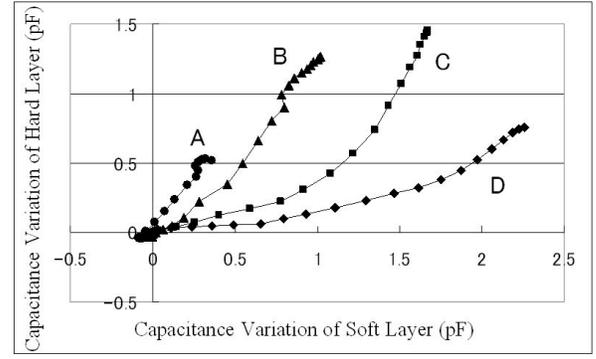


Fig. 7 Experimental result of basic performance. Measured trajectories of $(\Delta C_1, \Delta C_2)$ s for the stimulators A: $D = 0.5$ mm, B: $D = 10$ mm, C: $D = 20$ mm, and D: $D = 40$ mm.

1) *Basic Performance*: This experiment examined whether the sensor element prototype could discriminate four different acrylic circular-cylinder stimulators; A: $D = 0.5$ mm (as a concentrated load), B: $D = 10$ mm, C: $D = 20$ mm, and D: $D = 40$ mm (as a whole-area load). Each stimulator was vertically pressed at the center of the sensor element by hand with increasing force up to around 10 N in 0.5 s. Then the values of ΔC_1 and ΔC_2 increased with the contact force. In Fig. 7, the $(\Delta C_1, \Delta C_2)$ s during the motion are plotted. It is confirmed possible to discriminate the four stimulators.

2) *Effect of Surface Configuration*: A robot skin should perform well even when it is attached on a curved surface of a robot. This experiment examined whether the prototype could discriminate the four stimulators A, B, C, and D when it was placed on the base with the hemispherical bump shown in Fig. 8. As in 1), each stimulator was vertically pressed at the center of the sensor element by hand with increasing force up to around 10 N in 0.5 s. In Fig. 9, the $(\Delta C_1, \Delta C_2)$ s during the motion are plotted. It is also confirmed possible to discriminate the four stimulators when the element is attached to the curved surface.

3) *Effect of Contact Position*: The sensitivity of the sensor element is not affected by contact positions because C_n is a spatial integration value. This experiment examined whether the outputs of the prototype had some relationship with the contact positions on the surface of the prototype. We pressed the center and the corners of the sensor element as illustrated in Fig. 10 by the stimulator B. The other conditions were the same as the experiment in 1). In Fig. 11, the $(\Delta C_1, \Delta C_2)$ s during the motion are plotted. It is confirmed that the maximal deviation is about 0.2 pF and sufficiently small.

4) *Effect of Force Direction*: The sensor element is not sensitive to forces which are parallel to the surface of the element because only normal forces affect the distance between the conductive pieces. This experiment examined whether the outputs of the prototype had some relationship with the force direction, i.e. the existence of the surface shear stress. We pressed the center of the sensor element by the stimulator A not only vertically but also aslope at angles of $\pm 45^\circ$ from the vertical line. The other conditions were the same as the experiment in 1). In Fig. 12, the $(\Delta C_1, \Delta C_2)$ s

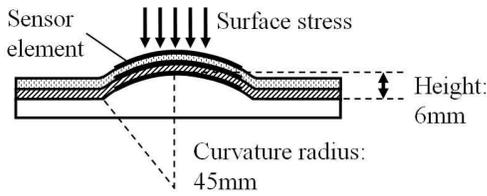


Fig. 8 Base with hemispherical bump.

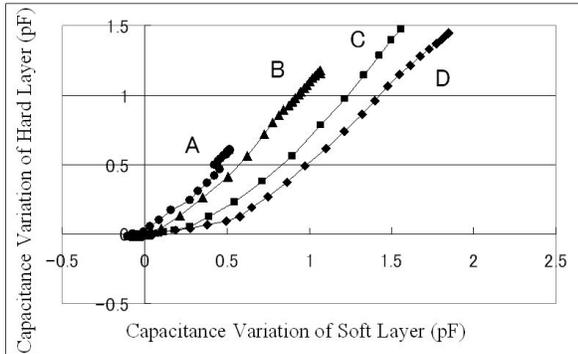


Fig. 9 Experimental result on effect of surface configuration. Measured trajectories of $(\Delta C_1, \Delta C_2)$ s for the stimulators A: $D = 0.5$ mm, B: $D = 10$ mm, C: $D = 20$ mm, and D: $D = 40$ mm.

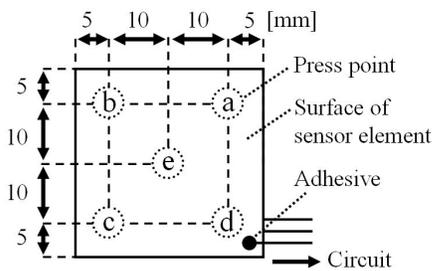


Fig. 10 Pressed positions; the center and the four corners.

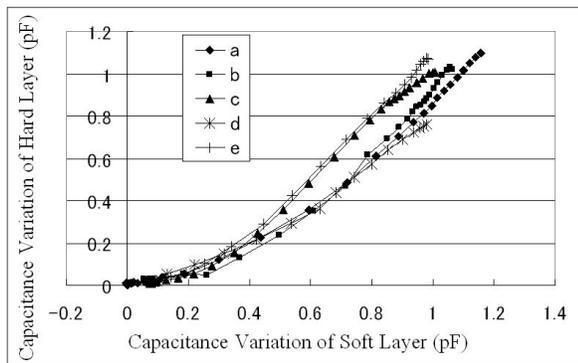


Fig. 11 Experimental result on effect of contact position. Measured trajectories of $(\Delta C_1, \Delta C_2)$ s for the stimulator B: $D = 10$ mm.

during the motion are plotted. It is confirmed that the maximal deviation is about 0.1 pF and sufficiently small.

5) *Effect of viscoelasticity*: Figs. 7, 9, 11, and 12 are the plots of $(\Delta C_1, \Delta C_2)$ during loading sequences. After that, a time delay until returning to the initial condition was observed when stimulator was released. This phenomenon is because of the viscoelasticity of the insulator layers. F and S are estimated as wrong values during the phenomenon that lasts about 1 s.

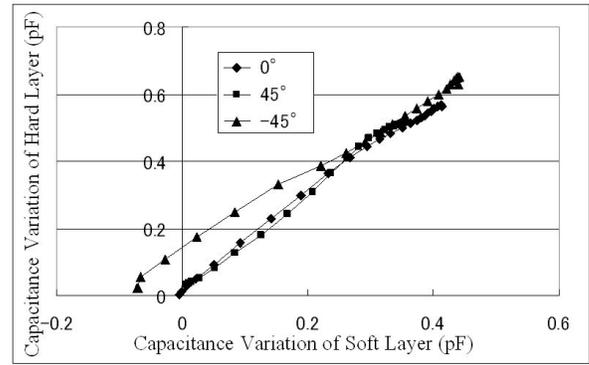


Fig. 12 Experimental result on effect of force direction. Measured trajectories of $(\Delta C_1, \Delta C_2)$ s for the stimulator A: $D = 0.5$ mm.

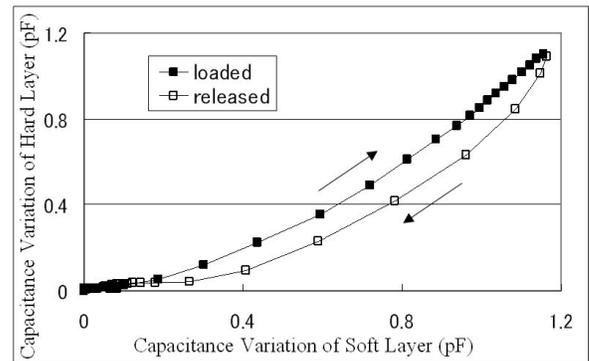


Fig. 13 Experimental result on effect of viscoelasticity. Measured trajectories of $(\Delta C_1, \Delta C_2)$ s for the stimulator B: $D = 10$ mm.

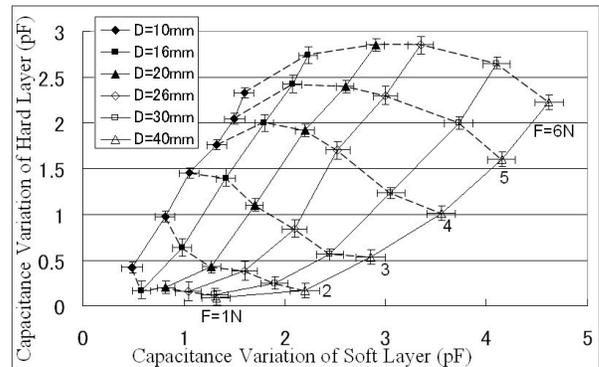


Fig. 14 Experimental result on reproducibility. Averaged trajectories of $(\Delta C_1, \Delta C_2)$ s for various (F, S) s with error bars representing maximal deviations.

6) *Reproducibility of Results*: This experiment examined whether the outputs of the prototype were reproducible. We used the six acrylic circular-cylinder stimulators with diameters $D = 10$ mm, 16 mm, 20 mm, 26 mm, 30 mm, and 40 mm. Each stimulator was vertically pressed at the center of the sensor element quasi-statically by a mechanical setup (a z-stage) measuring the pressing force. This setup is for more detailed data than the previous experiments, especially about the force. In Fig. 14, the averaged $(\Delta C_1, \Delta C_2)$ s of the five trials are plotted with the error bars representing the maximal deviations. It is confirmed that the outputs were stable during the five trials.

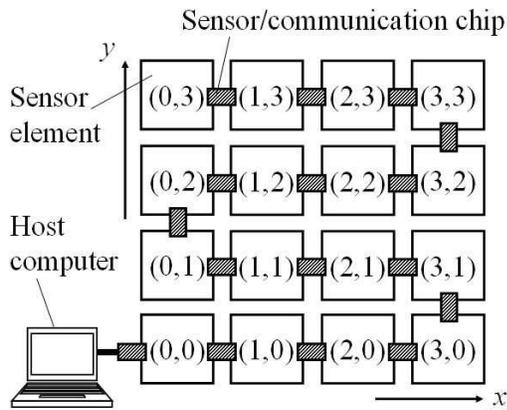


Fig. 15 Scheme of sensor skin. Each sensor element has its specific coordinate as shown in the figure.

III. SENSOR SKIN SYSTEM

A. Structure

We are developing a sensor/communication chip that measures the capacitance C_n and transmits signals to the host computer without long wires. Eliminating long wires is crucial to realize a practical elastic sensor skin. In our method, we use the conductive pieces of the sensor elements also for signal transmission. The scheme of the sensor skin system is illustrated in Fig. 15. The system consists of the arrayed sensor elements and the sensor/communication chips arranged at the boundaries of the sensor elements. While we will arrange the chips at all four sides of the sensor elements in future, we now connect the elements in a row for simplicity of the protocol. Each sensor element has its specific coordinate as shown in Fig. 15. The element with the coordinate (0, 3) is the most upstream, and the element with (0, 0) connected to the host computer is the most downstream. While the number of the sensor elements is only 16 in the current version, additional elements could be connected in the same manner.

The cross-section of the sensor skin is shown in Fig. 16. There are four conductive layers; the layers A, B, C, and D are the ground layer, the sensor/signal layer, the other sensor layer, and the power layer, respectively. The chips are connected to the conductive layers through electrode washers and fixed by plastic screws. The layers A and D (the ground and power layers) supply the chips with power. These two layers also function as electrostatic shields. The layers A and B sandwich the soft insulator layer forming the capacitor C_1 , and the layers B and C sandwich the hard insulator layer forming C_2 . The data packets are multi-hopped through the layer B (the signal layer) to the host computer.

B. Packets and Operations

In the current version of the protocol, two kinds of packets, the data packet and the command packet, are employed. The packets are transmitted downstream (see Fig. 15). The data packet contains the measured data and the coordinate of the sensor element, and the command packet contains the cue signal for the next chip to measure the capacitances of the sensor element.

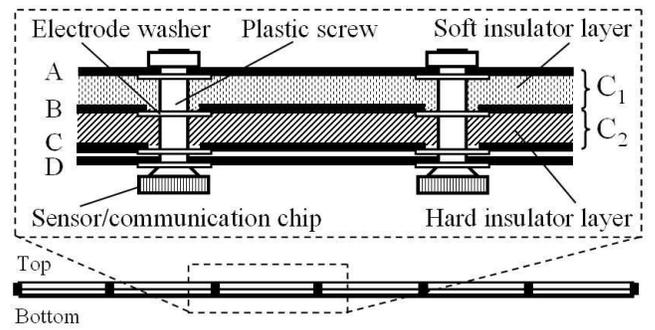


Fig. 16 Cross-section of robot skin using LSI chip. A: Ground layer, B: Sensor/signal layer, C: Sensor layer, and D: Power layer.

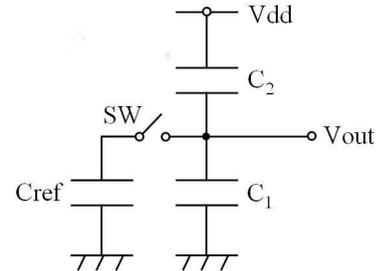


Fig. 17 Equivalent circuit of measurement system.

The chip is on standby when there is no packet. In receiving the data packet, the chip transfers the identical packet to the downstream chip through the signal layer. On the other hand, in receiving the command packet, the chip executes the following two-step sequence. Firstly, the chip measures the capacitances C_n and sends the data packet containing the measured data to downstream chip through the signal layer. Next, the chip generates and sends the command packet. By the iteration of this process, the host computer can gather the data from the all sensor elements. The most upstream chip connected to the (0, 3) sensor element alone executes the above sequence spontaneously at adequate intervals without waiting for the command packet.

C. Measurement Method

Fig. 17 shows the equivalent circuit of the measurement system. There is the reference capacitor C_{ref} inside the chip connected through a switch SW to the junction of the capacitors C_1 and C_2 . The chip measures the divided voltage V_{out} between the power voltage V_{dd} and the ground. The divided voltages are represented as

$$V_{out(OFF)} = \frac{C_2}{C_1 + C_2} V_{dd} \quad (9)$$

$$V_{out(ON)} = \frac{C_2}{C_1 + C_2 + C_{ref}} V_{dd} \quad (10)$$

where $V_{out(OFF)}$ and $V_{out(ON)}$ mean the voltages of the junction when the switch SW is off and on, respectively. The chip sends the values of $V_{out(OFF)}$ and $V_{out(ON)}$ after coding them by an A/D converter on the chip. We can know C_1 and C_2 by solving (9) and (10). The chip has the initialization process before the measurement of $V_{out(OFF)}$ and $V_{out(ON)}$ in which the charges in C_1 , C_2 and C_{ref} are all released.

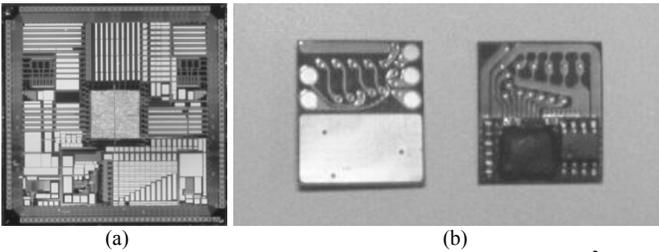


Fig. 18 (a) Closeup top view of first prototype of LSI ($5 \times 5 \text{ mm}^2$).
(b) LSI packaged on flexible substrate ($16 \times 18 \text{ mm}^2$, opened).

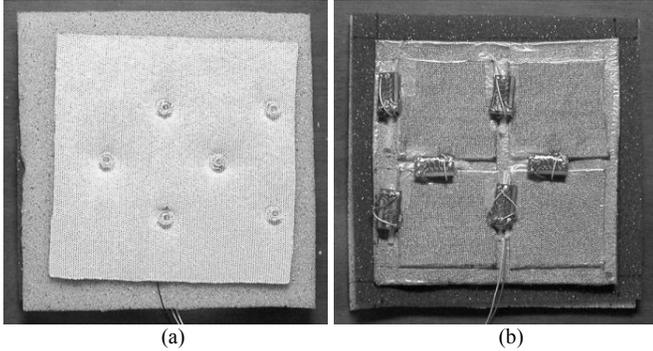


Fig. 19 Developed 2×2 tactile sensor array.
Each sensor element is $30 \times 30 \text{ mm}^2$.
(a) and (b) are top and bottom views of the test model.

D. Prototype of Sensor/communication Chip

At the present stage, we have completed fabrication of the first prototype of CMOS LSI based on $0.35 \mu\text{m}$ rules for the sensor/communication chip (Fig. 18 a). While the size of the LSI is $5 \times 5 \text{ mm}^2$, the total area of the analog-digital mixed circuits is within 1.5 mm^2 . The operating frequency of the LSI is 50 MHz. Each chip measures V_{out} with an 8-bit A/D converter and it has a function to transmit the data to the neighboring chip. We packaged the LSI on a compact ($16 \times 18 \text{ mm}^2$) flexible substrate (Fig. 18 b). It can be folded in half ($16 \times 9 \text{ mm}^2$). Although this first prototype needs an additional front-end circuit IC ($5 \times 6 \text{ mm}^2$), the next version will not need it and can be packaged in a substrate that is half in size from the present one.

E. Test Model of Robot Skin

We developed a test model of STAR using the first prototype of the LSI (Fig. 19). Because the protocol of the prototype is simpler than explained above, positions of the chips are different from Fig. 15 and there are additional layers for signal transmission (i.e. the layer B in Fig. 16 is only used as the sensor layer). The test model is a 2×2 array and the size of each element is $30 \times 30 \text{ mm}^2$. We verified that the chips measured the capacitances of the sensor elements and the data were transmitted to the host computer successfully.

IV. CONCLUSION

In this paper, we proposed a new tactile sensor skin, STAR. One component is a several-square-centimeter sensor element using the nonlinear elasticity to acquire not only a contact force but also a contact area. The other component is a

sensor/communication chip for a sensor network without long wires. By combining these two technologies, we can achieve a soft and stretchable robot skin. The developed test model of the robot skin is presented.

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